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TUSB8042

SLLSET2 - AUGUST 2017

TUSB8042 Four-Port USB 3.1 Gen1 Hub

Features 1

- Four Port USB 3.1 Gen1 Hub
- **USB 2.0 Hub Features**
 - Multi Transaction Translator (MTT) Hub: Four **Transaction Translators**
 - Two Asynchronous Endpoint Buffers Per **Transaction Translator**
- Supports Battery Charging:
 - Supports D+/D- Divider Charging Port (ACP1, ACP2, and ACP3) when the Upstream Port is Unconnected or not Configured
 - Supports Automatic Mode for Transition Between DCP or ACP Modes When the Upstream Port is Unconnected
 - Supports Galaxy Charging
 - CDP Mode (Upstream Port Connected)
 - DCP Mode (Upstream Port Unconnected)
 - DCP Mode Complies with Chinese Telecommunications Industry Standard YD/T 1591-2009
- Supports Operation as a USB 3.1 Gen1 or USB • 2.0 Compound Device
- Per Port or Ganged Power Switching and Over-٠ **Current Notification Inputs**
- Supports Four External Downstream Ports
- Supports Vendor Requests to Read and Write I²C . and EEPROM Read at 100 k and 400 k (Default)
- I²C Master Supports Clock Stretching
- OTP ROM, Serial EEPROM or I²C/SMBus Slave • Interface for Custom Configurations:
 - VID and PID
 - Port Customizations
 - Manufacturer and Product Strings (not by OTP) ROM)
 - Serial Number (not by OTP ROM)
- Application Feature Selection Using Pin Selection or EEPROM or I²C/SMBus Slave Interface
- Provides 128-Bit Universally Unique Identifier (UUID)
- Single Clock Input, 24-MHz Crystal or Oscillator
- Downstream Ports Configurable to USB2.0 Only
- 64-Pin QFN Package (RGC)

2 Applications

Computer Systems, Docking Stations, Monitors, Set-Top Boxes

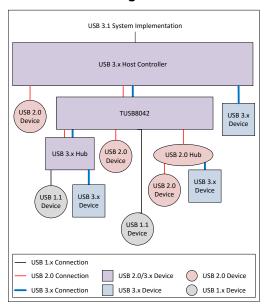
3 Description

The TUSB8042 is a four-port USB 3.1 Gen1 hub. It provides simultaneous SuperSpeed USB and highspeed/full-speed connections on the upstream port and provides SuperSpeed USB, high-speed, fullspeed, or low-speed connections on the downstream ports. When the upstream port is connected to an electrical environment that only supports high-speed or full-speed/low-speed connections, SuperSpeed USB connectivity is disabled on the downstream ports.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
TUSB8042	VQFN (64)	9.00 mm × 9.00 mm		

(1) For all available packages, see the orderable addendum at the end of the datasheet.



Diagram



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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Table 1.

DATE	REVISION	NOTES
August 2017	*	Initial release.



5 Description (Continued)

When the upstream port is connected to an electrical environment that only supports full-speed/low-speed connections, SuperSpeed USB and high-speed connectivity are disabled on the downstream ports.

The TUSB8042 supports per port or ganged power switching and over-current protection, and supports battery charging applications.

An individually port power controlled hub switches power on or off to each downstream port as requested by the USB host. Also when an individually port power controlled hub senses an over-current event, only power to the affected downstream port will be switched off.

A ganged hub switches on power to all its downstream ports when power is required to be on for any port. The power to the downstream ports is not switched off unless all ports are in a state that allows power to be removed. Also when a ganged hub senses an over-current event, power to all downstream ports will be switched off.

The TUSB8042 downstream ports provide support for battery charging applications by providing Battery Charging Downstream Port (CDP) handshaking support. It also supports a Dedicated Charging Port (DCP) mode when the upstream port is not connected. The DCP mode supports USB devices which support with the USB Battery Charging, Galaxy Charging, and Chinese Telecommunications Industry Standard YD/T 1591-2009. In addition when upstream port is unconnected, the TUSB8042 supports the divider charging port modes (ACPx modes) and an automatic transition through all modes, starting with ACP3 and ending in DCP.

The TUSB8042 provides pin strap configuration for some features including battery charging support, and also provides customization though OTP ROM, I²C EEPROM, or via an I²C/SMBus slave interface for PID, VID, and custom port and phy configurations. Custom string support is also available when using an I²C EEPROM or the I²C/SMBus slave interface.

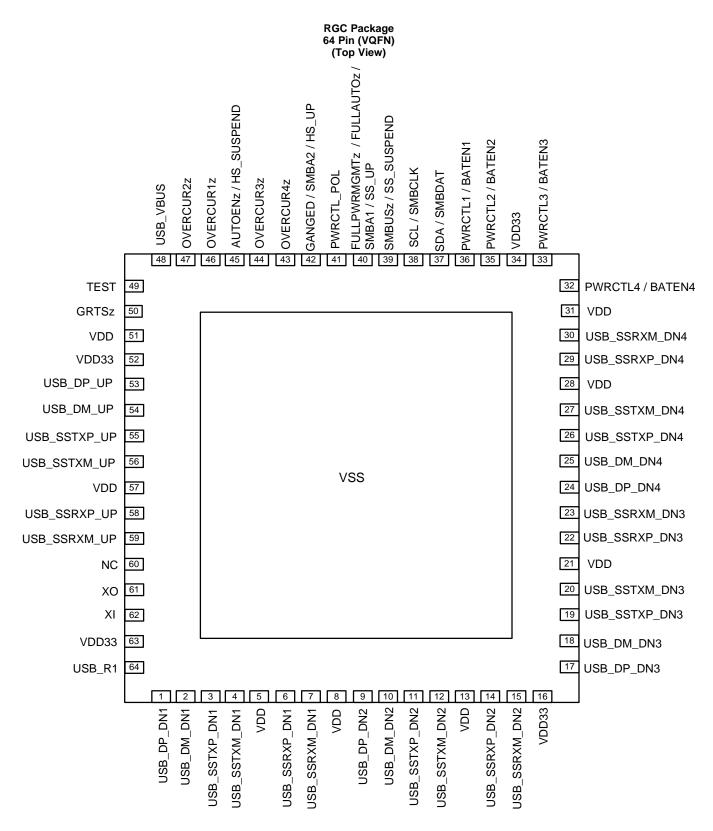
The device is available in a 64-pin RGC package and is offered in a commercial version for operation over the temperature range of 0°C to 70°C.

TUSB8042

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6 Pin Configuration and Functions



4



Pin Functions

PIN	PIN FUNCTIONS					
NAME	NO.	I/O	DESCRIPTION			
Clock and Reset Signals						
GRSTz	50	l PU	Global power reset. This reset brings all of the TUSB8042 internal registers to their default states. When GRSTz is asserted, the device is completely nonfunctional.			
XI	62	I	Crystal input. This pin is the crystal input for the internal oscillator. The input may alternately be driven by the output of an external oscillator. When using a crystal a 1-M Ω feedback resistor is required between XI and XO.			
хо	61	ο	Crystal output. This pin is the crystal output for the internal oscillator. If XI is driven by an external oscillator this pin may be left unconnected. When using a crystal a 1-M Ω feedback resistor is required between XI and XO.			
USB Upstream Signals	L					
USB_SSTXP_UP	55	0	USB SuperSpeed transmitter differential pair (positive)			
USB_SSTXM_UP	56	0	USB SuperSpeed transmitter differential pair (negative)			
USB_SSRXP_UP	58	I	USB SuperSpeed receiver differential pair (positive)			
USB_SSRXM_UP	59	I	USB SuperSpeed receiver differential pair (negative)			
USB_DP_UP	53	I/O	USB High-speed differential transceiver (positive)			
USB_DM_UP	54	I/O	USB High-speed differential transceiver (negative)			
USB_R1	64	I	Precision resistor reference. A 9.53-k Ω ±1% resistor should be connected between USB_R1 and GND.			
USB_VBUS	48	I	USB upstream port power monitor. The VBUS detection requires a voltage divider. The signal USB_VBUS must be connected to VBUS through a 90.9-K Ω ±1% resistor, and to ground through a 10-k Ω ±1% resistor from the signal to ground.			
USB Downstream Signa	ls					
USB_SSTXP_DN1	3	0	USB SuperSpeed transmitter differential pair (positive)			
USB_SSTXM_DN1	4	0	USB SuperSpeed transmitter differential pair (negative)			
USB_SSRXP_DN1	6	I	USB SuperSpeed receiver differential pair (positive)			
USB_SSRXM_DN1	7	I	USB SuperSpeed receiver differential pair (negative)			
USB_DP_DN1	1	I/O	USB High-speed differential transceiver (positive)			
USB_DM_DN1	2	I/O	USB High-speed differential transceiver (negative)			
			USB Port 1 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 1. This pin be left unconnected if power management is not implemented.			
PWRCTL1/BATEN1	36	I/O, PD	In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 1 as indicated in the Battery Charging Support register:			
			0 = Battery charging not supported			
			1 = Battery charging supported			
			USB Port 1 Over-Current Detection. This pin is typically connected to the over current output of the downstream port power switch for Port 1.			
			0 = An over current event has occurred			
OVERCUR1z	46	I, PU	1 = An over current event has not occurred			
			When GANGED power management is enabled, this pin or one of the other OVERCURz pins must be connected to the over current output of the power switch or circuit which detects the over current conditions. For the case when another OVERCURz pin is used, this pin can be left unconnected.			
USB_SSTXP_DN2	11	0	USB SuperSpeed transmitter differential pair (positive)			
USB_SSTXM_DN2	12	0	USB SuperSpeed transmitter differential pair (negative)			
USB_SSRXP_DN2	14	1	USB SuperSpeed receiver differential pair (positive)			
	14	-				
USB_SSRXM_DN2	15	I	USB SuperSpeed receiver differential pair (negative)			
USB_SSRXM_DN2 USB_DP_DN2			USB SuperSpeed receiver differential pair (negative) USB High-speed differential transceiver (positive)			

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Pin Functions (continued)

PIN			
NAME	NO.	I/O	DESCRIPTION
			USB Port 2 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 2. This pin be left unconnected if power management is not implemented.
PWRCTL2/BATEN2	35	I/O, PD	In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 2 as indicated in the Battery Charging Support register:
			0 = Battery charging not supported
			1 = Battery charging supported
			USB Port 2 Over-Current Detection. This pin is typically connected to the over current output of the downstream port power switch for Port 2.
			0 = An over current event has occurred
OVERCUR2z	47	I, PU	1 = An over current event has not occurred
			When GANGED power management is enabled, this pin or one of the other OVERCURz pins must be connected to the over current output of the power switch or circuit which detects the over current conditions. For the case when another OVERCURz pin is used, this pin can be left unconnected.
USB_SSTXP_DN3	19	0	USB SuperSpeed transmitter differential pair (positive)
USB_SSTXM_DN3	20	0	USB SuperSpeed transmitter differential pair (negative)
USB_SSRXP_DN3	22	I	USB SuperSpeed receiver differential pair (positive)
USB_SSRXM_DN3	23	I	USB SuperSpeed receiver differential pair (negative)
USB_DP_DN3	17	I/O	USB High-speed differential transceiver (positive)
USB_DM_DN3	18	I/O	USB High-speed differential transceiver (negative)
PWRCTL3/BATEN3	33	I/O, PD	USB Port 3 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 3. This pin be left unconnected if power management is not implemented. In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 3 as indicated in the Battery Charging Support
			register: 0 = Battery charging not supported
			 1 = Battery charging supported USB Port 3 Over-Current Detection. This pin is typically connected to the over current output of the downstream port power switch for Port 3.
			0 = An over current event has occurred
OVERCUR3z	44	I, PU	1 = An over current event has not occurred
UVERCOR32	44	1, FO	When GANGED power management is enabled, this pin or one of the other OVERCURz pins must be connected to the over current output of the power switch or circuit which detects the over current conditions. For the case when another OVERCURz pin is used, this pin can be left unconnected.
USB_SSTXP_DN4	26	0	USB SuperSpeed transmitter differential pair (positive)
USB_SSTXM_DN4	27	0	USB SuperSpeed transmitter differential pair (negative)
USB_SSRXP_DN4	29	I	USB SuperSpeed receiver differential pair (positive)
USB_SSRXM_DN4	30	I	USB SuperSpeed receiver differential pair (negative)
USB_DP_DN4	24	I/O	USB High-speed differential transceiver (positive)
USB_DM_DN4	25	I/O	USB High-speed differential transceiver (negative)
			USB Port 4 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 4. This pin be left unconnected if power management is not implemented.
PWRCTL4/BATEN4	32	I/O, PD	In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 4 as indicated in the Battery Charging Support register:
			0 = Battery charging not supported
			1 = Battery charging supported



Pin Functions (continued)

NAME NO. VO DESCRIPT OVERCUR4z 43 I, PU USB Port 4 Over-Current Detection. This pin is typ of the downstream port power switch for Port 4. OVERCUR4z 43 I, PU 1 = An over current event has occurred OVERCUR4z 43 I, PU 1 = An over current event has not occurred When GANGED power management is enabled, ti must be connected to the over current output of th over current conditions. For the case when another left unconnected. IPC/SMBUS I ² C Signals SCL/SMBCLK 38 I/O, PD I ² C clock/SMBus clock. Function of pin depends on When SMBUSz = 0, this pin acts as the serial of Can be left unconnected if external interface not in Can be left unconnected if external interface not in When SMBUSz = 0, this pin acts as the serial of Can be left unconnected if external interface not in When SMBUSz = 0, this pin acts as the serial of Can be left unconnected if external interface not in Can be left unconnected if external interface not in Can be left unconnected if external interface not in Can be left unconnected if external interface not in After reset, this signal indicates the SuperSpeed U Sa Susper at the de-assertion of reset set I ² C or SMBus mode selected SMBUSz/SS_SUSPEND 39 I/O, PU I ² C/SMBus Mode Selected 1 = I ² C Mode Selected 0 = SMBus Mode Selected 1 = I ² C Mode Selected 0 = SMBus Mode Selected 1 = I ² C Mode Selected 0 = SMBus Mode Selected 1 = I	
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Full power management enable/SMBus address b	onal Feature Configuration register. When
	•
	bit 1/SuperSpeed USB Connection Status
The value of the pin is sampled at the de-assertion follows:	n of reset to set the power switch control
0 = Power switching and over current inputs su	ipported
1 = Power switching and over current inputs no	ot supported
Full power management is the ability to control po TUSB8042 using PWRCTL[4:1]/BATEN[4:1].	ower to the downstream ports of the
FULLPWRMGMTz / If BATENx = 1 on any port, full power management terminal is sampled at the de-assertion to initialize FULLAUTOz / 40	
SMBA1/SS_UP When AUTOENz = 0 and FULLAUTOz = 0: all AC	CP modes are supported.
When AUTOENz = 0 and FULLAUTOz = 1:only hi mode.	ighest current ACP mode is used in auto
When SMBus mode is enabled, this pin sets the v	value of the SMBus slave address bit 1.
Can be left unconnected if full power managemen	t and SMBus are not implemented.
After reset, this signal indicates the SuperSpeed L if enabled through the stsOutputEn bit in the Addit enabled a value of 1 indicates the upstream port is port.	tional Feature Configuration register. When
Note: Power switching must be supported for batte	ery charging applications.
Power Control Polarity.	
PWRCTL_POL 41 I/O, PU The value of the pin is sampled at the de-assertion	n of reset to set the polarity of
0 = PWRCTL polarity is active low	
1 = PWRCTL polarity is active high	



Pin Functions (continued)

PIN		1/0	DESCRIPTION	
NAME	NO.	1/0	DESCRIPTION	
			Ganged operation enable/SMBus Address bit 2/HS Connection Status Upstream Port.	
			The value of the pin is sampled at the de-assertion of reset to set the power switch and over current detection mode as follows:	
			0 = Individual power control supported when power switching is enabled	
			1 = Power control gangs supported when power switching is enabled	
GANGED/SMBA2/ HS_UP	42	I/O, PD	When SMBus mode is enabled using SMBUSz, this pin sets the value of the SMBus slave address bit 2.	
			After reset, this signal indicates the High-speed USB connection status of the upstream port if enabled through the stsOutputEn bit in Additional Feature Configuration register. When enabled, a value of 1 indicates the upstream port is connected to a High-speed USB capable port.	
			Note: Individual power control must be enabled for battery charging applications.	
			Automatic Charge Mode Enable/HS Suspend Status.	
	45	I/O, PU	The value of the pin is sampled at the de-assertion of reset to determine if automatic mode is enabled as follows:	
AUTOENz/			0 = Automatic Mode is enabled on ports that are enabled for battery charging when the hub is unconnected. Please note that CDP is not supported on Port 1 when operating in Automatic mode.	
HS_SUSPEND			1 = Automatic Mode is disabled	
			This value is also used to set the autoEnz bit in the Battery Charging Support Register.	
			After reset, this signal indicates the High-speed USB Suspend status of the upstream port if enabled through the stsOutputEn bit in Additional Feature Configuration register. When enabled, a value of 1 indicates the connection is suspended.	
TEST	49	I, PD	This pin is reserved for factory test. It is suggested to have this pin pulled down to ground on PCB.	
Power and Ground Sign	als			
VDD	5, 8, 13, 21, 28, 31, 51, 57	PWR	1.1-V power rail	
VDD33	16, 34, 52, 63	PWR	3.3-V power rail	
VSS (Thermal Pad)		PWR	Ground. Thermal pad must be connected to ground.	
NC	60	—	No connect, leave floating	



7 Specifications

7.1 Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
	V _{DD} Steady-state supply voltage	-0.3	1.4	V
Supply Voltage Range	V _{DD33} Steady-state supply voltage	pply voltage -0.3 3.8		V
	USB_SSRXP_UP, USB_SSRXN_UP, USB_SSRXP_DN[4:1], USB_SSRXN_DP[4:1] and USB_VBUS terminals	-0.3	1.4	V
Voltage Range	XI terminals	-0.3	2.45	V
	All other terminals	-0.3	3.8	V
Storage temperature, T _{st}	q	-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
		Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	
V _(ESD)	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101 $^{\left(2\right) }$	±500	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

			MIN	NOM	MAX	UNIT
VDD ⁽¹⁾	1.1V supply voltage		0.99	1.1	1.26	V
VDD33	3.3V supply voltage		3	3.3	3.6	V
USB_VBUS	Voltage at USB_VBUS PAD				1.155	V
T _A	Operating free-air temperature	TUSB8042	0		70	°C
TJ	Operating junction temperature		-40		105	°C

(1) A 1.05-V, 1.1-V, or 1.2-V supply may be used as long as minimum and maximum supply conditions are met.

7.4 Thermal Information

		TUSB8042	
	THERMAL METRIC ⁽¹⁾	RGC	UNIT
		64 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	26	°C/W
$R_{\theta JCtop}$	Junction-to-case (top) thermal resistance	11.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	5.3	°C/W
ΨJT	Junction-to-top characterization parameter	0.2	°C/W
ΨJB	Junction-to-board characterization parameter	5.2	°C/W
$R_{\theta JCbot}$	Junction-to-case (bottom) thermal resistance	1.0	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

7.5 Electrical Characteristics, 3.3-V I/O

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	OPERATION	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{IH}	High-level input voltage ⁽¹⁾	VDD33		2		VDD33	V
V _{IL}	Low-level input voltage ⁽¹⁾	VDD33		0		0.8	V
VI	Input voltage			0		VDD33	V
Vo	Output voltage ⁽²⁾			0		VDD33	V
t _t	Input transition time $(t_{rise} and t_{fall})$			0		25	ns
V _{hys}	Input hysteresis ⁽³⁾					0.13 x VDD33	V
V _{OH}	High-level output voltage	VDD33	I _{OH} = -4 mA	2.4			V
V _{OL}	Low-level output voltage	VDD33	$I_{OL} = 4 \text{ mA}$			0.4	V
I _{OZ}	High-impedance, output current ⁽²⁾	VDD33	$V_{I} = 0$ to VDD33			±20	μA
I _{OZP}	High-impedance, output current with internal pullup or pulldown resistor ⁽⁴⁾	VDD33	$V_{I} = 0$ to VDD33			±250	μA
l _l	Input current ⁽⁵⁾	VDD33	$V_{I} = 0$ to VDD33			±15	μA
R_{PD}	Internal pull-down resister			13.5	19	27.5	KΩ
R _{PU}	Internal pull-up resistor			14.5	19	25	KΩ

(1) Applies to external inputs and bidirectional buffers.

(2) Applies to external outputs and bidirectional buffers.

(3) Applies to GRSTz.

(4) Applies to pins with internal pullups/pulldowns.

(5) Applies to external input buffers.

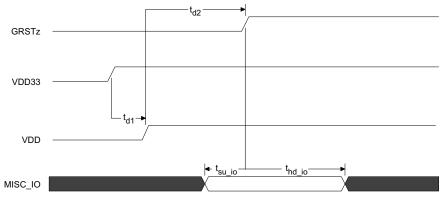
7.6 Timing Requirements, Power-Up

PARAMETER	DESCRIPTION	MIN	TYP I	AN	UNIT
t _{d1}	VDD33 stable before VDD stable ⁽¹⁾	See (2)			ms
t _{d2}	VDD and VDD33 stable before de-assertion of GRSTz	3			ms
t _{su_io}	Setup for MISC inputs ⁽³⁾ sampled at the de-assertion of GRSTz	0.1			μs
t _{hd_io}	Hold for MISC inputs $^{(3)}$ sampled at the de-assertion of GRSTz	0.1			μs
t _{VDD33_RAMP}	VDD33 supply ramp requirements	0.2		100	ms
t _{VDD_RAMP}	VDD supply ramp requirements	0.2		100	ms

(1) An active reset is required if the VDD33 supply is stable before the VDD11 supply. This active Reset shall meet the 3ms power-up delay counting from both power supplies being stable to the de-assertion of GRSTz.

(2) There is no power-on relationship between VDD33 and VDD unless GRSTz is only connected to a capacitor to GND. Then VDD must be stable minimum of 10 μs before the VDD33.

(3) MISC pins sampled at de-assertion of GRSTz: BATEN[4:1], AUTOENz, FULLPWRMGMTz, GANGED, SMBUSz, and PWRCTL_POL.







7.7 Hub Input Supply Current

Typical values measured at $T_A = 25^{\circ}C$

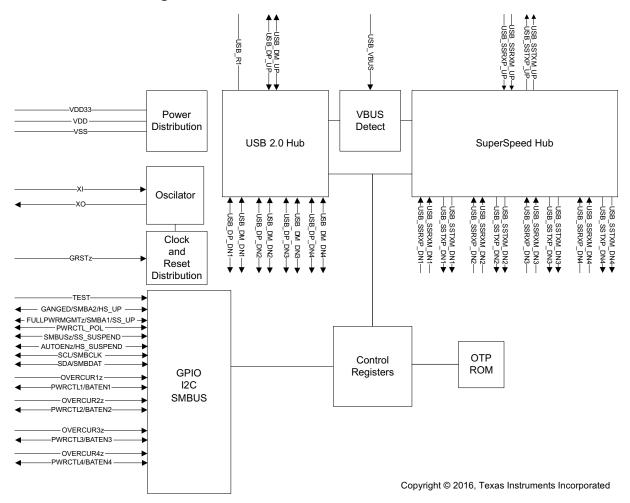
DADAMETED	VDD33	VDD	LINUT
PARAMETER	3.3 V	1.1 V	UNIT
LOW POWER MODES		;	
Power On (after Reset)	3	30	mA
Upstream Disconnect	3	24	mA
Suspend	3	30	mA
ACTIVE MODES (US state / DS State)			
3.0 host / 1 SS Device and Hub in U1 / U2	45	240	mA
3.0 host / 1 SS Device and Hub in U0	45	356	mA
3.0 host / 2 SS Devices and Hub in U1 / U2	45	301	mA
3.0 host / 2 SS Devices and Hub in U0	45	457	mA
3.0 host / 3 SS Devices and Hub in U1 / U2	45	372	mA
3.0 host / 3 SS Devices and Hub in U0	45	563	mA
3.0 host / 4 SS Devices and Hub in U1 / U2	45	440	mA
3.0 host / 4 SS Devices and Hub in U0	45	672	mA
3.0 host / 1 SS Device in U0 and 1 HS Device	84	372	mA
3.0 host / 2 SS Devices in U0 and 2 HS Devices	95	512	mA
2.0 host / HS Device	45	55	mA
2.0 host / 4 HS Devices	76	74	mA

8 Detailed Description

8.1 Overview

The TUSB8042 is a four-port USB 3.1 Gen1 compliant hub. It provides simultaneous SuperSpeed USB and highspeed/full-speed connections on the upstream port and provides SuperSpeed USB, high-speed, full-speed, or low-speed connections on the downstream ports. When the upstream port is connected to an electrical environment that only supports high-speed or full-speed/low-speed connections, SuperSpeed USB connectivity is disabled on the downstream ports. When the upstream port is connected to an electrical environment that only supports full-speed/low-speed connections, SuperSpeed USB and high-speed connectivity are disabled on the downstream ports.

8.2 Functional Block Diagram



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8.3 Feature Description

8.3.1 Battery Charging Features

The TUSB8042 provides support for USB Battery Charging (BC1.2) and custom charging. Battery charging support may be enabled on a per port basis through the REG_6h(batEn[3:0]).

USB Battery charging support includes both Charging Downstream Port (CDP) and Dedicated Charging Port (DCP) modes. The DCP mode is compliant with the Chinese Telecommunications Industry Standard YD/T 1591-2009. CDP is enabled when the upstream port has detected valid VBUS, configured, and host sets port power. When the upstream port is not connected and battery charging support is enabled, the TUSB8042 will enable DCP mode.

In addition to USB Battery charging (BC1.2), the TUSB8042 supports custom charging indications: Divider Charging (ACP3, ACP2, ACP1 modes), and Galaxy compatible charging. These custom charging modes are only supported when upstream port is unconnected and AUTOMODE is enabled. When in AUTOMODE and upstream port is disconnected, the port will automatically transition from ACP mode to the DCP mode depending on the portable device connected. The divided mode places a fixed DC voltage on the ports DP and DM signals which allows some devices to identify the capabilities of the charger. The default divider mode indicates support for up to 10W (ACP3). The divider mode can be configured to report a lower-current setting (up to 5 W) through REG_0Ah (HiCurAcpModeEn).

When the upstream port is not connected and battery charging support is enabled for a port, the TUSB8042 drives the port power enable active. If AUTOMODE is disabled, then DCP mode is used. If AUTOMODE is enabled and FullAutoEn bit is cleared (Reg_25h Bit 0), then TUSB8042 will start with highest enabled divider current mode (ACPx). The TUSB8042 will remain in highest current mode as long as a pull-up is not detected on DP pin. If an pull-up is detected on DP pin, then TUSB8042 will drive the port power enable inactive and switch to Galaxy mode, if enabled, or to DCP mode if Galaxy mode is disabled. The TUSB8042 will again drive the port power enable active. The TUSB8042 will remain in Galaxy mode as long as no pull-up is detected on DP pin. If an pull-up is detected on DP pin, then TUSB8042 will drive the port power enable inactive and transition to DCP mode. The TUSB8042 will again drive the port power enable inactive and transition to DCP mode. The TUSB8042 will again drive the port power enable active. In DCP mode, the TUSB8042 will look for a pull-up detected on DP pin or RxVdat. If a pull-up or RxVdat is detected on DP, the TUSB8042 will drive the port power enable inactive and transition back to ACPx mode. This sequence will repeat until upstream port is connected.

When Automatic mode is enabled and full automatic mode (FullAutoEn Reg_25h bit 0) is enabled, TUSB8042 will perform same sequence described in previous paragraph with the addition of attempting all supported ACPx modes before sequencing to Galaxy Mode (if enabled) or DCP mode.

The supported battery charging modes when TUSB8042 configured for SMBus or external EEPROM is detailed in Battery Charging Modes with SMBus/EEPROM Table.

The supported battery charging modes when TUSB8042 configured for I2C but without an external EEPROM is determined by the sampled state of the pins. These modes are detailed in Battery Charging Modes without EEPROM Table.



Feature Description (continued)

Table 2. TUSB8042 Battery Charging Modes with SMBus or I2C EEPROM

batEn[n] Reg_06h Bits 3:0	Upstream VBUS	HiCurAcpMode En Reg_0Ah Bit 4	autoModeEnz Reg_0Ah Bit 1	FullAutoEn Reg_25h Bit 0	Galaxy_Enz Reg_25h Bit 1	Battery Charging Mode Port x (x = n + 1)
0	Don't Care	Don't Care	Don't Care	Don't Care	Don't Care	No Charging support
1	> 4V	Don't Care	Don't Care	Don't Care	Don't Care	CDP
1	< 4V	Don't Care	1	Don't Care	Don't Care	DCP
1	< 4V	0	0	1	1	AUTOMODE enabled. Sequences through all ACPx modes and DCP with the exception of ACP3 Alternate ACP2, ACP1, DCP
1	< 4V	1	0	1	1	AUTOMODE enabled. Sequences through all ACPx modes and DCP. Alternate ACP3, ACP2, ACP1, DCP
1	< 4 V	0	0	0	1	AUTOMODE enabled. Sequences between ACP2 and DCP. Alternate ACP2, DCP
1	< 4V	1	0	0	1	AUTOMODE enabled. Sequences between ACP3 and DCP. Alternate ACP3, DCP
1	< 4V	0	0	1	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP2, ACP1, Galaxy, DCP.
1	< 4V	1	0	1	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP3, ACP2, ACP1, Galaxy, DCP
1	< 4V	0	0	0	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP2, Galaxy, DCP
1	< 4V	1	0	0	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP3, Galaxy, DCP

Table 3. TUSB8042 Battery Charging Modes without EEPROM

BATEN[3:0] pins	Upstream VBUS	AUTOENz pin	FULLAUTO2 pin	Battery Charging Mode Port x (x = n + 1)
0	Don't Care	Don't Care	Don't Care	No Charging support
1	> 4V	Don't Care	Don't Care	CDP
1	< 4V	1	0	DCP
1	< 4V	0	0	AUTOMODE enabled with Galaxy compatible charging support. Sequences through all ACPx modes. Alternate ACP3, ACP2, ACP1, Galaxy, DCP.
1	< 4V	0	1	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP3, Galaxy, DCP
1	< 4V	1	1	AUTOMODE enabled. Sequences through all ACPx modes. Alternate ACP3, ACP2, ACP1, DCP.



8.3.2 USB Power Management

The TUSB8042 can be configured for power switched applications using either per-port (Full power managed) or ganged power-enable controls and over-current status inputs. When battery charge is enabled, the TUSB8042 will always function in full power managed.

Power switch support is enabled by REG_5h (fullPwrMgmtz) and the per-port or ganged mode is configured by REG_5h(ganged).

The TUSB8042 supports both active high and active low power-enable controls. The PWRCTL[4:1] polarity is configured by REG_Ah(pwrctlPol).

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8.3.3 One Time Programmable (OTP) Configuration

The TUSB8042 allows device configuration through one time programmable non-volatile memory (OTP). The programming of the OTP is supported using vendor-defined USB device requests. For details using the OTP features please contact your TI representative.

Table 4 provides a list features which may be configured using the OTP.

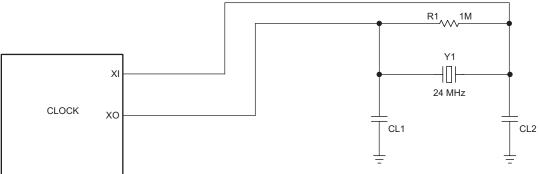
Table 4. OTP Configurable Features

CONFIGURATION REGISTER OFFSET	BIT FIELD	DESCRIPTION
REG_01h	[7:0]	Vendor ID LSB
REG_02h	[7:0]	Vendor ID MSB
REG_03h	[7:0]	Product ID LSB
REG_04h	[7:0]	Product ID MSB
REG_07h	[0]	Port removable configuration for downstream ports 1. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_07h	[1]	Port removable configuration for downstream ports 2. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_07h	[2]	Port removable configuration for downstream ports 3. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_07h	[3]	Port removable configuration for downstream ports 4. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_08h	[3:0]	Port used Configured register.
REG_0Ah	[3]	Enable Device Attach Detection
REG_0Ah	[4]	High-current divider mode enable.
REG_0Bh	[0]	USB 2.0 port polarity configuration for downstream ports 1.
REG_0Bh	[1]	USB 2.0 port polarity configuration for downstream ports 2.
REG_0Bh	[2]	USB 2.0 port polarity configuration for downstream ports 3.
REG_0Bh	[3]	USB 2.0 port polarity configuration for downstream ports 4.
REG_25h	[4:0]	Device Configuration Register 3
REG_26h	[3:0]	USB2.0 Only Port Register
REG_F0h	[3:1]	USB power switch power-on delay.



8.3.4 Clock Generation

The TUSB8042 accepts a crystal input to drive an internal oscillator or an external clock source. If a clock is provided to XI instead of a crystal, XO is left open. Otherwise, if a crystal is used, the connection needs to follow the guidelines below. Since XI and XO are coupled to other leads and supplies on the PCB, it is important to keep them as short as possible and away from any switching leads. It is also recommended to minimize the capacitance between XI and XO. This can be accomplished by shielding C1 and C2 with the clean ground lines.



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Figure 2. TUSB8042 Clock



8.3.5 Crystal Requirements

The crystal must be fundamental mode with load capacitance of 12 pF - 24 pF and frequency stability rating of ± 100 PPM or better. To ensure proper startup oscillation condition, a maximum crystal equivalent series resistance (ESR) of 50 Ω is recommended. A parallel load capacitor should be used if a crystal source is used. The exact load capacitance value used depends on the crystal vendor. Refer to application note *Selection and Specification for Crystals for Texas Instruments USB2.0 devices* (SLLA122) for details on how to determine the load capacitance value.

8.3.6 Input Clock Requirements

When using an external clock source such as an oscillator, the reference clock should have a ±100 PPM or better frequency stability and have less than 50-ps absolute peak to peak jitter or less than 25-ps peak to peak jitter after applying the USB 3.1 jitter transfer function. XI should be tied to the 1.8-V clock source and XO should be left floating.

8.3.7 Power-Up and Reset

The TUSB8042 does not have specific power sequencing requirements with respect to the core power (VDD) or I/O and analog power (VDD33) as long as GRSTz is held in an asserted state while supplies ramp. The core power (VDD) or I/O power (VDD33) may be powered up for an indefinite period of time while the other is not powered up if all of these constraints are met:

- All maximum ratings and recommended operating conditions are observed.
- All warnings about exposure to maximum rated and recommended conditions are observed, particularly junction temperature. These apply to power transitions as well as normal operation.
- Bus contention while VDD33 is powered up must be limited to 100 hours over the projected life-time of the device.
- Bus contention while VDD33 is powered down may violate the absolute maximum ratings.

A supply bus is powered up when the voltage is within the recommended operating range. It is powered down when it is below that range, either stable or in transition.

A minimum reset duration of 3 ms is required. This is defined as the time when the power supplies are in the recommended operating range to the de-assertion of GRSTz. This can be generated using programmable-delay supervisory device or using an RC circuit. When a RC circuit is used, the external capacitor size chosen must be large enough to meet the 3ms minimum duration requirement. The R of the RC circuit is the internal R_{PU}.



8.4 Device Functional Modes

8.4.1 External Configuration Interface

The TUSB8042 supports a serial interface for configuration register access. The device may be configured by an attached I²C EEPROM or accessed as a slave by an external SMBus master. The external interface is enabled when both the SCL/SMBCLK and SDA/SMBDAT pins are pulled up to 3.3 V at the de-assertion of reset. The mode, I²C master or SMBus slave, is determined by the state of SMBUSz/SS_SUSPEND pin at reset.

8.4.2 I²C EEPROM Operation

The TUSB8042 supports a single-master, fast mode (400KHz) connection to a dedicated I²C EEPROM when the I²C interface mode is enabled. In I²C mode, the TUSB8042 reads the contents of the EEPROM at bus address 1010000b using 7-bit addressing starting at address 0. The TUSB8042 will read the entire EEPROM contents using a single burst read transaction. The burst read transaction will end when the address reaches FFh.

If the value of the EEPROM contents at address byte 00h equals 55h, the TUSB8042 loads the configuration registers according to the EEPROM map. If the first byte is not 55h, the TUSB8042 exits the I²C mode and continues execution with the default values in the configuration registers. The hub will not connect on the upstream port until the configuration is completed.

NOTE

The bytes located above offset Ah are optional. The requirement for data in those addresses is dependent on the options configured in the Device Configuration, and Device Configuration 2 registers.

The minimum size I²C EEPROM required is 2Kbit.

For details on I²C operation refer to the UM10204 I²C-bus Specification and User Manual.

8.4.3 Port Configuration

The TUSB8042 port configurations can be selected by registers or efuse. The Port Used Configuration register (USED[3:0]) define how many ports can possibly be reported by the hub. The device removable configuration register (RMBL[3:0]) define if the ports that are reported as used have permanently connected devices or not. The USB 2.0 Only Port register (USB2_ONLY[3:0]) define whether or a used port is reported as part of the USB 2.0 hub or both the USB2.0 and USB3.1 hubs. The USB2_ONLY field will enable the USB2.0 port even if the corresponding USED bit is low. The table below shows examples of the possible combinations.



Device Functional Modes (continued)

USED[3:0]	RMBL[3:0]	USB2_ONLY [3:0]	Reported Port Configuration	Physical to Logical Port mapping
1111	1111	0000	4 Port USB3.1 Hub 4 Port USB2.0 Hub	Physical1 => Logical Port1 for USB3.1 and USB2.0. Physical2 => Logical Port2 for USB3.1 and USB2.0. Physical3 => Logical Port3 for USB3.1 and USB2.0. Physical4 => Logical Port4 for USB3.1 and USB2.0.
1110	1111	0000	3 Port USB3.1 Hub Port USB2.0 Hub	Physical1 Not used. Physical2 => Logical Port1 for USB3.1 and USB2.0. Physical3 => Logical Port2 for USB3.1 and USB2.0. Physical4 => Logical Port3 for USB3.1 and USB2.0.
1100	0111	0000	2 Port USB 3.1 Hub 2 Port USB2.0 hub with permanently attached device on Port 2	Physical1 Not used. Physical2 Not used. Physical3 => Logical Port1 for USB3.1 and USB2.0. Physical4 => Logical Port2 for USB3.1 and USB2.0.
0011	1111	0010	1 Port USB 3.1 Hub 2 Port USB 2.0 Hub	Physical1 => Logical Port1 for USB3.1 and USB2.0. Physical2 => Logical Port2 for USB2.0. Physical3 Not Used. Physical4 Not used.
1000	1111	0010	1 Port USB 3.1 Hub 2 Port USB 2.0 Hub	Physical1 Not used. Physical2 => Logical Port2 for USB2.0. Physical3 Not used Physical4 => Logical Port1 for USB3.1 and USB2.0.
1111	1111	1110	1 Port USB 3.1 Hub 4 Port USB 2.0 Hub	Physical1 => Logical Port1 for USB3.1 and USB2.0. Physical2 => Logical Port2 for USB2.0. Physical3 => Logical Port3 for USB2.0. Physical4 => Logical Port4 for USB2.0.
1010	N/A	0x0x	Invalid combination when USB2_ONLY = 0000, 0001, 0100, or 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	
1011	N/A	0x01	Invalid combination when USB2_ONLY = 0001 or 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	
1110	N/A	010x	Invalid combination when USB2_ONLY = 0100 or 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	
1111	N/A	0101	Invalid combination when USB2_ONLY = 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	



8.4.4 SMBus Slave Operation

When the SMBus interface mode is enabled, the TUSB8042 supports read block and write block protocols as a slave-only SMBus device.

The TUSB8042 slave address is 1000 1xyz, where:

- x is the state of GANGED/SMBA2/HS_UP pin at reset,
- y is the state of FULLPWRMGMTz/SMBA1/SS_UP pin at reset, and
- z is the read/write bit; 1 = read access, 0 = write access.

If the TUSB8042 is addressed by a host using an unsupported protocol it will not respond. The TUSB8042 waits indefinitely for configuration by the SMBus host and will not connect on the upstream port until the SMBus host indicates configuration is complete by clearing the CFG_ACTIVE bit.

For details on SMBus requirements, refer to the System Management Bus Specification.

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8.5 Register Maps

8.5.1 Configuration Registers

The internal configuration registers are accessed on byte boundaries. The configuration register values are loaded with defaults but can be over-written when the TUSB8042 is in I^2C or SMBus mode.

BYTE ADDRESS	CONTENTS	EEPROM CONFIGURABLE					
00h	ROM Signature Register	Yes					
01h	Vendor ID LSB	Yes					
02h	Vendor ID MSB	Yes					
03h	Product ID LSB	Yes					
04h	Product ID MSB	Yes					
05h	Device Configuration Register	Yes					
06h	Battery Charging Support Register	Yes					
07h	Device Removable Configuration Register	Yes					
08h	Port Used Configuration Register	Yes					
09h	Reserved. Must default to 00h.	Yes					
0Ah	Device Configuration Register 2	Yes					
0Bh	USB 2.0 Port Polarity Control Register	Yes					
0Ch-0Fh	Reserved	No					
10h-1Fh	UUID Byte [15:0]	No					
20h-21h	LangID Byte [1:0]	Yes					
22h	Serial Number Length	Yes					
23h	Manufacturer String Length	Yes					
24h	Product String Length	Yes					
25h	Device Configuration Register 3	Yes					
26h	USB 2.0 Only Port Register	Yes					
27h-2Eh	Reserved	Yes					
2Fh	Reserved	No					
30h-4Fh	Serial Number String Byte [31:0]	Yes					
50h-8Fh	Manufacturer String Byte [63:0]	Yes					
90h-CFh	Product String Byte [63:0]	Yes					
D0h-D4h	Reserved	Yes ⁽¹⁾					
D5h-D7h	Reserved	No					
D8h-DCh	Reserved	Yes ⁽¹⁾					
DDh-EFh	Reserved	No					
F0h	Additional Features Configuration Register	Yes					
F1h-F7h	Reserved	No					
F8h	SMBus Device Status and Command Register	No					
F9h - FFh	Reserved	No					

Table 6. TUSB8042 Register Map



8.5.2 ROM Signature Register

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0
	Table 7. Bit Descriptions – ROM Signature Register							
Bit	Field		Туре	Descrip	tion			
7:0	romSignature		RW	mode to first byte match, t	ROM Signature Register. This register is used by the TUSB8042 in I^2 mode to validate the attached EEPROM has been programmed. The first byte of the EEPROM is compared to the mask 55h and if not a match, the TUSB8042 aborts the EEPROM load and executes with th register defaults.			

Figure 3. Register Offset 0h

8.5.3 Vendor ID LSB Register

Figure 4. Register Offset 1h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	1	0	1	0	0	0	1

Table 8. Bit Descriptions – Vendor ID LSB Register

Bit	Field	Туре	Description
7:0	vendorldLsb	RO/RW	Vendor ID LSB. Least significant byte of the unique vendor ID assigned by the USB-IF; the default value of this register is 51h representing the LSB of the TI Vendor ID 0451h. The value may be over-written to indicate a customer Vendor ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 51h.

8.5.4 Vendor ID MSB Register

Figure 5. Register Offset 2h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	1	0	0

Table 9. Bit Descriptions – Vendor ID MSB Register

Bit	Field	Туре	Description
7:0	vendorldMsb	RO/RW	Vendor ID MSB. Most significant byte of the unique vendor ID assigned by the USB-IF; the default value of this register is 04h representing the MSB of the TI Vendor ID 0451h. The value may be over-written to indicate a customer Vendor ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 04h.

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8.5.5 Product ID LSB Register

Bit No. 3 2 7 6 5 4 1 0 **Reset State** 0 1 0 0 0 0 0 0 Table 10. Bit Descriptions – Product ID LSB Register Bit Field Туре Description Product ID LSB. Least significant byte of the product ID assigned by Texas Instruments and reported in the SuperSpeed Device descriptor. the default value of this register is 40h representing the LSB of the SuperSpeed product ID assigned by Texas Instruments The value reported in the USB 2.0 Device descriptor is the value of this register bit wise XORed with 00000010b. The value may be over-written to RO/RW productIdLsb 7:0 indicate a customer product ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 40h.

Figure 6. Register Offset 3h

8.5.6 Product ID MSB Register

Bit No.	7	6	5	4	3	2	1	0
Reset State	1	0	0	0	0	0	1	0

Table 11. Bit Descriptions – Product ID MSB Register

Bit	Field	Туре	Description
7:0	productIdMsb	RO/RW	Product ID MSB. Most significant byte of the product ID assigned by Texas Instruments; the default value of this register is 82h representing the MSB of the product ID assigned by Texas Instruments. The value may be over-written to indicate a customer product ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 82h.



8.5.7 Device Configuration Register

Reset State 0 0 1 X X 0 0 Table 12. Bit Descriptions - Device Configuration Register Bit Field Type Description 7 custom Strings RW Custom string tength, Manufacture String, Product String, Includer String, Product String,	Bit No.	7	6	5		4	3	2	1	0
Bit Field Type Description 7 custom Strings enable. This bit controls the ability to write to the Manufacturer String. Product String Length, Manufacturer String, Product String Length, Product String, and Language ID registers are read only 1 = The Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers are read only 1 = The Manufacture String Length, Manufacturer String, Product String Length, Product String, and Language ID registers are read only 1 = The Manufacture String Length, Manufacturer String Product String Length, Product String and Language ID registers are read only 1 = The Manufacture String Length, Manufacture String registers may be loaded by EEPROM or written by SMBus The default value of this bit s 0. 6 customSemum RW Custom sering Length and Serial Number String registers may be loaded by EEPROM or written by SMBus The default value of this bit s 0. 5 u1u2Disable RW U1 U2 Disable. This bit controls the U1/U2 support. 6 u1u2Disable RW Custom sering point. 7 u1u2Disable RW Custom sering point. 8 u1u2Disable RW Custom sering point. 9 u1u2Disable RW Custom sering point. 1 u1u2Disable RW Custom sering point. RW 3 ganged RW		0				1			0	0
7 customStrings enable. This bit controls the ability to write to the Manufacturer String Length, Manufacturer String, Product String enable. The Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers are read only 1 = The Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers may be loaded by EEPROM or written by SMBus The default value of this bit is 0. 6 customSemum Custom String Length, Manufacturer String Length, Product String, and Language ID registers may be loaded by EEPROM or written by SMBus The default value of this bit is 0. 6 customSemum RW Custom String Length, and Serial Number String registers are read only 1 = Serial Number String Length and Serial Number String registers are read only 1 = Serial Number String Length and Serial Number String registers are read only 1 = Serial Number String Length and Serial Number String registers are read only 1 = Serial Number String Length and Serial Number String registers are read only 1 = U1/U2 Disable. This bit controls the U1/U2 support. 0 = U1/U2 support is disabled, the TUSB8042 will not initiate or accept nuy U1 or U2 requests on any port, upstream Ownstream, unless it receives or sends a Force_LinkPM Accept LMP. After receiving or sending an FLPM LMP, it will continue to enable U1 and U2 according to USB 3.1 protocol unill tigets a power-on reset or is disconnected on its upstream port. When the TUSB8042 is in MEUS mode, the value may be over- written by an SMBus host. 4 RSVD RO Reserved. This bit is noted the de-assertion of reset with the contents of the EEPROM. When the TUSB8042 is in SMEUS mode, the value may be over- written by an SMBus host.			Table 12.	Bit Desc	riptions -	Devic	e Configuratio	on Register		
7 customStrings RW Manufacturer String Length, Manufacturer String, Product String, Length, Product String, and Language ID registers are read only 1 = The Manufacturer String Length, Manufacturer String, Product String, Length, Product String, Prothed String, P	Bit	Field			Туре	Descrip	otion			
6 customSernum RW 0 = The Serial Number String Length and Serial Number String registers are read only. 6 customSernum RW 1 = Serial Number String Length and Serial Number String registers may be loaded by EEPROM or written by SMBus The default value of this bit is 0. 5 u1u2Disable U1 U2 Disable. This bit controls the U1/U2 support. 5 u1u2Disable RW 2 expression Series and the U1/U2 support. 5 u1u2Disable RW 2 expression Series and the U1/U2 support. 6 customSeries and the U1/U2 support is enabled 1 = U1/U2 support is enabled 1 u1u2Disable RW 2 expression Series a Force LinkPM. Accept LMP. After receiving or sending an FLPMA LMP, it will continue to enable U1 and U2 according to USB 3.1 protocol until it gets a power-on reset or is disconnected on its upstream port. 4 RSVD RO Reserved. This bit is loaded at the de-assertion of reset with the value of the GANGED/SMBA2/HS_UP pin. 3 ganged RW 2 Ganged. This bit is loaded at the de-assertion of reset with the value of the GANGED/SMBA2/HS_UP pin. 2 fullPwrMgmtz RW 2 Reserved. This bit is loaded at the de-assertion of reset with the value of the GANGED/SMBA2/HS_UP pin. 3 ganged RW 2 Reserved. This bit is loaded at the de-assertion of reset with th	7	customStrings			RW	Manufa Length, 0 = The String L 1 = The String L Ioaded	cturer String Lengt Product String, ar Manufacturer Stri ength, Product Stri Manufacturer Stri ength, Product Stri ength, Product Stri by EEPROM or wr	h, Manufactur Id Language II Ing Length, Ma ing, and Lang Ing Length, Ma ing, and Lang itten by SMBu	er String, Produ D registers nufacturer Strir uage ID registe nufacturer Strir uage ID registe	uct String ng, Product rs are read only ng, Product
9 U1/U2 support is disabled. the TUSB8042 will not initiate or accept any U1 or U2 requests on any port, upstream or downstream, unless it receives or sends a Force_LinkPM_Accept LMP. After receiving or sending an FLPMA LMP, it will continue to enable U1 and U2 according to USB 3.1 protocol until it gets a power-on reset or is disconnected on its upstream port. When the TUSB8042 is in I ² C mode, the TUSB8042 loads this bit from the contents of the EEPROM. 4 RSVD RO Reserved. This bit is reserved and returns 1 when read. 3 ganged RW Ganged. This bit is reserved and returns 1 when read. 3 ganged RW Ferserved. This bit is reserved and returns 1 when read. 3 ganged RW Ferserved. This bit is loaded at the de-assertion of reset with the value of the GANGED/SMBA2/HS_UP pin. 3 ganged RW Sanged. This Dit is loaded at the de-assertion of reset with the value of the GANGED/SMBA2/HS_UP pin. 4 RSVD RW Ferserved. This Dit is loaded at the de-assertion of reset with the value of the GANGED/SMBA2/HS_UP pin. 3 ganged RW Ferserved. Sin I ² C mode, the TUSB8042 loads this bit from the contents of the EEPROM. 4 Numer the TUSB8042 is in I ² C mode, the TUSB8042 loads this bit from the contents of the EEPROM. Ferserved. This bit is loaded at the de-assertion of reset with the value of the TUSB8042 is in I ² C mode, the TUSB8042 loads this bit from the contents of the EEPROM. 4 RW FullPwrMigmtz = 0, each port is individually power switch	6	customSernum			RW	serial no 0 = The register 1 = Seri may be	umber registers. Serial Number St s are read only ial Number String I loaded by EEPRC	ring Length an Length and Se M or written b	d Serial Numbe	er String
3 ganged RW Ganged. This bit is loaded at the de-assertion of reset with the value of the GANGED/SMBA2/HS_UP pin. 0 = When fullPwrMgmtz = 0, each port is individually power switched and enabled by the PWRCTL[4:1]/BATEN[4:1] pins 3 a denabled by the PWRCTL[4:1]/BATEN[4:1] pins 1 = When fullPwrMgmtz = 0, the power switch control for all ports is ganged and enabled by the PWRCTL[4:1]/BATEN1 pin 2 fullPwrMgmtz Full Power Management. This bit is loaded at the de-assertion of reset with the value of the CULPWRMGMTZ/SMBA1/SS_UP pin. 2 fullPwrMgmtz RW Full Power Management. This bit is loaded at the de-assertion of reset with the value of the FULLPWRMGMTZ/SMBA1/SS_UP pin. 2 fullPwrMgmtz RW Full Power switching status reporting is enabled 1 u1u2TimerOvr RW RW Full Power Switching status reporting is disabled When the TUSB8042 is in 1 ² C mode, the TUSB8042 loads this bit from the contents of the EEPROM. 1 u1u2TimerOvr RW U1 U2 Timer Override. When this field is set, the TUSB8042 will over-written by an SMBUs host. 1 U1u2TimerOvr RW U1 U2 Timer Override. When this field is set, the TUSB8042 will over-write by an SMBUs host. 1 U1u2TimerOvr RW U1 U2 Timer Override. When this field is set, the TUSB8042 will over-write by an SMBUs host. 1 U1u2TimerOvr RW U1 U2 Timer O	5	u1u2Disable			RW	0 = U1// 1 = U1// any U1 receives sending accordin disconn When the the cont When the	U2 support is enable U2 support is disale or U2 requests on s or sends a Force g an FLPMA LMP, ng to USB 3.1 prot lected on its upstre he TUSB8042 is in tents of the EEPR0 he TUSB8042 is in	bled bled, the TUSI any port, ups: _LinkPM_Acc it will continue ocol until it ge sam port. I ² C mode, the DM. SMBUS mod	B8042 will not in tream or downs ept LMP. After to enable U1 a ts a power-on r TUSB8042 loa	tream, unless it receiving or nd U2 eset or is ads this bit from
3 ganged RW the GANGED/SMBA2/HS_UP pin. 0 = When fullPwrMgmtz = 0, each port is individually power switched and enabled by the PWRCTL[4:1]/BATEN[4:1] pins 1 = When fullPwrMgmtz = 0, the power switch control for all ports is ganged and enabled by the PWRCTL[4:1]/BATEN1 pin When the TUSB8042 is in I ² C mode, the TUSB8042 loads this bit from the contents of the EPROM. When the TUSB8042 is in SMBUS mode, the value may be over- written by an SMBus host. 2 fullPwrMgmtz RW Full Power Management. This bit is loaded at the de-assertion of reset with the value of the FULLPWRMGMTz/SMBA1/SS_UP pin. 0 = Port power switching status reporting is enabled 1 = Port power switching status reporting is disabled When the TUSB8042 is in I ² C mode, the TUSB8042 loads this bit from the contents of the EEPROM. When the TUSB8042 is in SMBUS mode, the value may be over- written by an SMBus host. 1 u1u2TimerOvr RW U1 U2 Timer Override. When this field is set, the TUSB8042 will override the downstream ports U1/U2 timeout values set by USB3.1 Host software. If software sets value in the range of 1h - FFh, the TUSB8042 will use the value of FFh. If software sets value to 0, then TUSB8042 will use value of 0.	4	RSVD			RO	Reserve	ed. This bit is rese	ved and retur	ns 1 when read	
2 fullPwrMgmtz RW with the value of the FULLPWRMGMTz/SMBA1/SS_UP pin. 0 = Port power switching status reporting is enabled 1 = Port power switching status reporting is disabled When the TUSB8042 is in I ² C mode, the TUSB8042 loads this bit from the contents of the EEPROM. When the TUSB8042 is in SMBUS mode, the value may be over- written by an SMBus host. 1 u1u2TimerOvr RW U1 U2 Timer Override. When this field is set, the TUSB8042 will override the downstream ports U1/U2 timeout values set by USB3.1 Host software. If software sets value in the range of 1h - FFh, the TUSB8042 will use the value of FFh. If software sets value to 0, then TUSB8042 will use value of 0.	3	ganged			RW	the GAN 0 = Who and ena 1 = Who ganged When th the com When th	NGED/SMBA2/HS en fullPwrMgmtz = abled by the PWR(en fullPwrMgmtz = and enabled by th he TUSB8042 is in tents of the EEPR(he TUSB8042 is in	_UP pin. 0, each port i CTL[4:1]/BATE 0, the power e PWRCTL[4: I ² C mode, the DM. SMBUS mod	s individually po N[4:1] pins switch control fo 1]/BATEN1 pin TUSB8042 loa	ower switched or all ports is ads this bit from
1 u1u2TimerOvr RW override the downstream ports U1/U2 timeout values set by USB3.1 1 Host software. If software sets value in the range of 1h - FFh, the TUSB8042 will use the value of FFh. If software sets value to 0, then TUSB8042 will use value of 0.	2	fullPwrMgmtz			RW	with the 0 = Port 1 = Port When the the cont When the	e value of the FULL t power switching s t power switching s he TUSB8042 is in tents of the EEPR(he TUSB8042 is in	PWRMGMTz/ status reportin status reportin I ² C mode, the OM. SMBUS mod	/SMBA1/SS_UF g is enabled g is disabled e TUSB8042 loa	^o pin. ads this bit from
0 RSVD RO Reserved. This field is reserved and returns 0 when read.	1	u1u2TimerOvr			RW	override Host so TUSB80	e the downstream iftware. If software 042 will use the va	oorts U1/U2 tir sets value in t lue of FFh. If s	neout values se he range of 1h	et by USB3.1 - FFh, the
	0	RSVD			RO	Reserve	ed. This field is res	erved and retu	urns 0 when rea	ad.

Figure 8. Register Offset 5h

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8.5.8 Battery Charging Support Register

Bit No.	7	6	5	4	3	2	1	0				
Reset State	0	0	0	0	Х	Х	Х	Х				
	Table 13. Bit Descriptions – Battery Charging Support Register											
Bit	Bit Field Type Description											
7:4	RSVD		RO	Reserve	d. Read only, ret	urns 0 when rea	ad.					
3:0	batEn[3:0]		RW	downstre 0 = The 1 = The Each bit correspo downstre The defa with the When in	Charger Support. eam port implement port is not enabled port is enabled for corresponds dire ands to downstrea eam port 2. juit value for these value of PWRCT I2C/SMBus moot d contents or by	ents the chargin ed for battery ch or battery charg ectly to a downs am port 1, and t se bits are loade "L/BATEN[3:0]. de the bits in this	ng port features. harging support features tream port, i.e. to batEN1 corresponded at the de-asset s field may be on	eatures ures patEn0 onds to ertion of reset				

Figure 9. Register Offset 6h

8.5.9 Device Removable Configuration Register

Figure 10. Register Offset 7h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	Х	Х	Х	Х

Table 14. Bit Descriptions – Device Removable Configuration Register

Bit	Field	Туре	Description
7	customRmbl	RW	Custom Removable. This bit controls the ability to write to the port removable bits, port used bits, and USB2_ONLY bits. 0 = rmbl[3:0], used[3:0], and USB2_ONLY[3:0] are read only and the values are loaded from the OTP ROM 1 = rmbl[3:0], used[3:0], and USB2_ONLY[3:0] are read/write and can be loaded by EEPROM or written by SMBus This bit may be written simultaneously with rmbl[3:0].
6:4	RSVD	RO	Reserved. Read only, returns 0 when read.
3:0	rmbl[3:0]	RO/RW	Removable. The bits in this field indicate whether a device attached to downstream ports 4 through 1 are removable or permanently attached. 0 = The device attached to the port is not removable 1 = The device attached to the port is removable Each bit corresponds directly to a downstream port n + 1, i.e. rmbl0 corresponds to downstream port 1, rmbl1 corresponds to downstream port 2, etc. This field is read only unless the customRmbl bit is set to 1. Otherwise the value of this filed reflects the inverted values of the OTP ROM non_rmb[3:0] field.

8.5.10 Port Used Configuration Register

Figure 11. Register Offset 8h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	1	1	1	1



		-	
Bit	Field	Туре	Description
7:4	RSVD	RO	Reserved. Read only.
3:0	used[3:0]	RO/RW	Used. The bits in this field indicate whether a port is enabled. 0 = The port is not used or disabled 1 = The port is used or enabled Each bit corresponds directly to a downstream port, i.e. used0 corresponds to downstream port 1, used1 corresponds to downstream port 2, etc. All combinations are supported with the exception of both ports 1 and 3 marked as disabled. This field is read only unless the customRmbl bit is set to 1. When the corresponding USB2_ONLY bit is set, the USB2 port will be used and enabled regardless of the bit programmed into this field.

Table 15. Bit Descriptions – Port Used Configuration Register

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8.5.11 Device Configuration Register 2

Bit No.	7	6	5		4	3	2	1	0
Reset State	0	0	Х		1	0	0	0	0
		Table 16. Bit	Descrip	otions – I	Device	Configuratio	on Register 2	2	
Bit	Field		٦	Гуре	Descrip	tion			
7	Reserved		F	RO	Reserve	d. Read-only, re	turns 0 when rea	ad.	
6	customBCfeatur	res	F	RW	to write t 0 = The the OTP 1 = The EEPROI	Battery Charging to the battery char HiCurAcpModeE ROM. HiCurAcpModeE M or written by S may be written si	arging feature co in is read only a in bit is read/wri MBus.	nfiguration con nd the values a te and can be lo	trols. re loaded from paded by
5	pwrctlPol	F	RW	with the 0 = PWF 1 = PWF When the the contents When the	nable polarity. Ti value of the PW RCTL polarity is a RCTL polarity is a e TUSB8042 is i ents of the EEPF e TUSB8042 is i y an SMBus hos	RCTL_POL pin. active low active high n I ² C mode, the ROM. n SMBUS mode	TUSB8042 load	ds this bit from	
4	HiCurAcpModeE	F	RO/RW	High-current ACP mode enable. This bit enables the high-current table charging mode when the automatic battery charging mode is enabled for downstream ports. 0 = High current divider mode disabled . High current is ACP2 (default 1 = High current divider mode enabled. High current mode is ACP3 This bit is read only unless the customBCfeatures bit is set to 1. If customBCfeatures is 0, the value of this bit reflects the value of the OTP ROM HiCurAcpModeEn bit.					
3:2	Reserved		F	RW	Reserve	d			
1	autoModeEnz		F		 Automatic Mode Enable. This bit is loaded at the de-assertion of rest with the value of the AUTOENz/HS_SUSPEND pin. The automatic mode only applies to downstream ports with battery charging enabled when the upstream port is not connected. Under these conditions: 0 = Automatic mode battery charging features are enabled. 1 = Automatic mode is disabled; only Battery Charging DCP and CD mode is supported. NOTE: When the upstream port is connected, Battery Charging CDF mode will be supported on all ports that are enabled for battery charging support regardless of the value of this bit. 				
0	RSVD		F	RO	Reserve	d. Read only, ret	urns 0 when rea	ad.	

Figure 12. Register Offset Ah



8.5.12 USB 2.0 Port Polarity Control Register

Figure 13. Register Offset Bh

Bit No.	7	6	5		4	3	2	1	0	
Reset State	0	0	0		0	0	0	0	0	
	Tabl	le 17. Bit D	escripti	ons – US	B 2.0 F	Port Polarity	Control Regi	ster		
Bit	Field			Туре	Descri	ption				
7	customPolarity			RW	p[4:0]_ 0 = The from th 1 = The EEPRC	usb2pol bits. e p[4:0]_usb2pol e OTP ROM. e p[4:0]_usb2pol DM or written by	ty. This bit contro bits are read only bits are read/writ SMBus. simultaneously w	y and the value e and can be lo	s are loaded baded by	
6:5	RSVD			RO	Reserv	red. Read only, r	eturns 0 when rea	ad.		
4	p4_usb2pol			RO/RW	port. 0 = US 1 = US out, i.e This bit custom	B 2.0 port polari B 2.0 port polari . DM becomes D t is read only unl	/DP Polarity. This y is as document y is swapped from P, and DP becomess the customPo- value of this bit re	ed by the pin o m that documer nes DM. blarity bit is set	ut hted in the pin to 1. If	
3	p3_usb2pol			RO/RW	port. 0 = US 1 = US out, i.e This bit custom	wnstream Port 3 DM/DP Polarity. This controls the polarity of the rt. = USB 2.0 port polarity is as documented by the pin out = USB 2.0 port polarity is swapped from that documented in the pin t, i.e. DM becomes DP, and DP becomes DM. is bit is read only unless the customPolarity bit is set to 1. If stomPolarity is 0 the value of this bit reflects the value of the OTP DM p3_usb2pol bit.				
2	p2_usb2pol			RO/RW	Downstream Port 2 DM/DP Polarity. This controls the polarity of the port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in the out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the OT ROM p2_usb2pol bit.					
1	p1_usb2pol			RORW	 NOM p2_usb2p0 bit. Downstream Port 1 DM/DP Polarity. This controls the polarity port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the ROM p1_usb2pol bit. 					
0	p0_usb2pol			RO/RW	Upstream Port DM/DP Polarity. This controls the polarity of the port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in the pir out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the OTP ROM p0_usb2pol bit.					

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8.5.13 UUID Registers

Figure 14. Register Offset 10h-1Fh

Bit No. Reset State	7 X	6 X	5 X	4 X	3 X	2 X	1 X	0 X	
		Table 18	3. Bit Descript	tions – U	UID Byte N R	Register			
Bit	Field Type Description								
7:0	uuidByte[n]		RO	UUID byte N. The UUID returned in the Container ID descriptor. The value of this register is provided by the device and is meets the UUII requirements of Internet Engineering Task Force (IETF) RFC 4122 A UUID URN Namespace.					

8.5.14 Language ID LSB Register

Figure 15. Register Offset 20h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	1	0	0	1

Table 19. Bit Descriptions – Language ID LSB Register

Bit	Field	Туре	Description
7:0	langldLsb	RO/RW	Language ID least significant byte. This register contains the value returned in the LSB of the LANGID code in string index 0. The TUSB8042 only supports one language ID. The default value of this register is 09h representing the LSB of the LangID 0409h indicating English United States. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host.

8.5.15 Language ID MSB Register

Figure 16. Register Offset 21h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 20. Bit Descriptions – Language ID MSB Register

Bit	Field	Туре	Description
7:0	langldMsb	RO/RW	Language ID most significant byte. This register contains the value returned in the MSB of the LANGID code in string index 0. The TUSB8042 only supports one language ID. The default value of this register is 04h representing the MSB of the LangID 0409h indicating English United States. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host.



8.5.16 Serial Number String Length Register

Bit No.	7	6	5	4	3	2	1	0		
Reset State	0	0	0	1	1	0	0	0		
	Tab	le 21. Bit De	scriptions – S	erial Nur	nber String I	_ength Regi	ster			
Bit	Field		Туре	Descrip	Description					
7:6	RSVD		RO	Reserve	Reserved. Read only, returns 0 when read.					
5:0	serNumStringLer	ſ	RO/RW Serial number string length. The string length in bytes for number string. The default value is 18h indicating that a number string is supported. The maximum string length When customSernum is 1, this field may be over-written contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a serial number string of serNumbStringLen bytes is returned at string index 1 fro contained in the Serial Number String registers.							

Figure 17. Register Offset 22h

8.5.17 Manufacturer String Length Register

Figure 18. Register Offset 23h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 22. Bit Descriptions – Manufacturer String Length Register

Bit	Field	Туре	Description
7	RSVD	RO	Reserved. Read only, returns 0 when read.
6:0	mfgStringLen	RO/RW	Manufacturer string length. The string length in bytes for the manufacturer string. The default value is 0, indicating that a manufacturer string is not provided. The maximum string length is 64 bytes. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a manufacturer string of mfgStringLen bytes is returned at string index 3 from the data contained in the Manufacturer String registers.

8.5.18 Product String Length Register

Figure 19. Register Offset 24h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 23. Bit Descriptions – Product String Length Register

Bit	Field	Туре	Description
7	RSVD	RO	Reserved. Read only, returns 0 when read.
6:0	prodStringLen	RO/RW	Product string length. The string length in bytes for the product string. The default value is 0, indicating that a product string is not provided. The maximum string length is 64 bytes. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a product string of prodStringLen bytes is returned at string index 3 from the data contained in the Product String registers.

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8.5.19 Device Configuration Register 3

Bit No.	7	6	5	4	3	2	1	0			
Reset State	0	0	0	0	0	0	0	0			
		Table 24. Bit	Descriptions	– Device	Configuratio	on Register 3	8				
Bit	Field		Туре	Descrip	tion						
7:5	RSVD		RO	Reserve	ed. Read only, ret	urns 0 when rea	ıd.				
4	USB2.0_only		RW	from rep USB SS the USE This bit this bit a	USB 2.0 hub reports as 2.0 only. This bit disables the USB 2.0 hub from reporting 5Gbps support in the wSpeedsSupported field of the USB SS BOS SS device capability descriptor. This bit will also disable the USB3.0 hub. This bit is read/write but the read value returned is the Boolean OR of this bit and the corresponding eFuse bit. If either bit is set, this feature is enabled.						
3	Reserved		RO	Switch t	o reserved						
2	I2C_100k		R/W	I2C 100kHz. This bit controls the clock rate of the I2C master for bo USB to I2C requests . The EEPROM reads will occur at 400K unles eFuse is used to set the rate to 100k. This bit is read/write but the read value returned is the Boolean OR this bit and the corresponding eFuse bit. If either bit is set, this feature is enabled.							
1	Galaxy_Enz		R/W	Disable Galaxy compatible modes. When this field is high, Galaxy charging compatible mode will not be included in AUTOMODE charsequence. This bit is read/write but the read value returned is the Boolean OF this bit and the corresponding eFuse bit. If either bit is set, this fear is disabled.							
0	FullAutoEn		R/W	Enable all divider battery charging modes. When automode is enable and this bit is set, any DS port enabled for battery charging will atter all divider battery charging modes before DCP, starting with the highest current option. The bit is writable, but the value read back is the Boolean OR of this bit and the corresponding eFuse control. If either bit is set, eFuse or this register, this feature is enabled.							

Figure 20. Register Offset 25h

8.5.20 USB 2.0 Only Port Register

Figure 21. Register Offset 26h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 25. Bit Descriptions – USB 2.0 Only Port Register

Bit	Field	Туре	Description
7:4	RSVD	RO	Reserved. Read only, returns 0 when read.
3:0	USB2_ONLY[3:0]	RO/RW	USB 2.0 Only Ports. The bits in this field primarily indicate whether a port is enabled only for USB 2.0 operation. This field is read-only unless customRmbl bit is set. Also, these bits will override the corresponding USED bit. A value of 0 indicates the hub port is enabled for both USB 3.1 and USB 2.0. A value of 1 indicates the hub port is enabled only for USB 2.0 operation.

8.5.21 Serial Number String Registers



	Figure 22. Register Offset 30h-4Fh								
Bit No.	7	6	5	4	3	2	1	0	
Reset State	Х	Х	х	х	х	х	х	х	
Bit	Table 26. Bit Descriptions – Serial Number Registers Bit Field Type Description								
7:0	serialNumber[n]		RO/RW	Serial Number byte N. The serial number returned in the Serial Number string descriptor at string index 1. The default value of the registers is assigned by TI. When customSernum is 1, these regis may be over-written by EEPROM contents or by an SMBus host.					

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8.5.22 Manufacturer String Registers

Bit No.	7	6	5	4	3	2	1	0			
Reset State	0	0	0	0	0	0	0	0			
	Table 27. Bit Descriptions – Manufacturer String Registers										
Bit	Field Type			Descrip	Description						
7:0	mfgStringByte[n]		RW	returned number The prog as define	Manufacturer string byte N. These registers provide the string valu returned for string index 3 when mfgStringLen is greater than 0. Th number of bytes returned in the string is equal to mfgStringLen. The programmed data should be in UNICODE UTF-16LE encoding as defined by The Unicode Standard, Worldwide Character Encoding Version 5.0.						

Figure 23. Register Offset 50h-8Fh

8.5.23 Product String Registers

Figure 24. Register Offset 90h-CFh

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 28. Bit Descriptions – Product String Byte N Register

Bit	Field	Туре	Description
7:0	prodStringByte[n]	RO/RW	Product string byte N. These registers provide the string values returned for string index 2 when prodStringLen is greater than 0. The number of bytes returned in the string is equal to prodStringLen. The programmed data should be in UNICODE UTF-16LE encodings as defined by The Unicode Standard, Worldwide Character Encoding, Version 5.0.



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usb3spreadDis

8.5.24 Additional Feature Configuration Register

Bit No.	7	6	5	4	3	2	1	0		
Reset State	0	0	0	0	0	0	0	0		
	Table 29. Bit Descriptions – Additional Feature Configuration Register									
Bit	Field		Туре	Descrip	Description					
7:5	Reserved		RW	Reserve	ed. This field defa	aults to 3'b000 a	nd must not be	changed.		
4	stsOutputEn		RW	signals, 0 = STS 1 = STS	utput enable. Th HS_UP, HS_SU outputs are disa outputs are ena may be loaded b	SPEND, SS_UF abled. bled.	P, SS_SUSPEN	D.		
3:1	pwronTime		RW	field sets enable o example	On Delay Time. V s the delay time f of PWRCTL when e, when disabling he nominal timin	from the removant transitioning but the power on a	al disable of PW attery charging transition from	RCTL to the modes. For		

host.

RW

TPWRON_EN = (pwronTime x 1) x 200 ms

spread spectrum function of the USB3 phy PLL.

0 = Spread spectrum function is enabled

This field may be over-written by EEPROM contents or by an SMBus

USB3 Spread Spectrum Disable. This bit allows firmware to disable the

1= Spread spectrum function is disabled This bit may be loaded by EEPROM or over-written by a SMBUS host.

Figure 25. Register Offset F0h

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8.5.25 SMBus Device Status and Command Register

Figure 26	. Register	Offset F8h
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Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 30. Bit Descriptions – SMBus Device Status and Command Register

Bit	Field	Туре	Description
7:2	RSVD	RO	Reserved. Read only, returns 0 when read.
1	smbusRst	RSU	SMBus interface reset. This bit loads the registers back to their GRSTz values. Note, that since this bit can only be set when in SMBus mode the cfgActive bit is also reset to 1. When software sets this bit it must reconfigure the registers as necessary. This bit is set by writing a 1 and is cleared by hardware on completion of the reset. A write of 0 has no effect.
0	cfgActive	RCU	Configuration active. This bit indicates that configuration of the TUSB8042 is currently active. The bit is set by hardware when the device enters the I2C or SMBus mode. The TUSB8042 shall not connect on the upstream port while this bit is 1. When in I2C mode, the bit is cleared by hardware when the TUSB8042 exits the I2C mode. When in the SMBus mode, this bit must be cleared by the SMBus host in order to exit the configuration mode and allow the upstream port to connect. The bit is cleared by a writing 1. A write of 0 has no effect.



9 Applications and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The TUSB8042 is a four-port USB 3.1 Gen1 compliant hub. It provides simultaneous SuperSpeed USB and highspeed/full-speed connections on the upstream port and provides SuperSpeed USB, high-speed, full-speed, or low speed connections on the downstream port. The TUSB8042 can be used in any application that needs additional USB compliant ports. For example, a specific notebook may only have two downstream USB ports. By using the TUSB8042, the notebook can increase the downstream port count to five.

9.2 Typical Application

9.2.1 Discrete USB Hub Product

A common application for the TUSB8042 is as a self powered standalone USB hub product. The product is powered by an external 5V DC Power adapter. In this application, using a USB cable TUSB8042 upstream port is plugged into a USB Host controller. The downstream ports of the TUSB8042 are exposed to users for connecting USB hard drives, cameras, flash drives, and so forth.

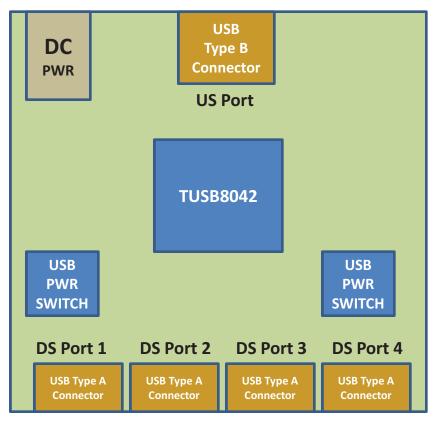


Figure 27. Discrete USB Hub Product

Typical Application (continued)

9.2.1.1 Design Requirements

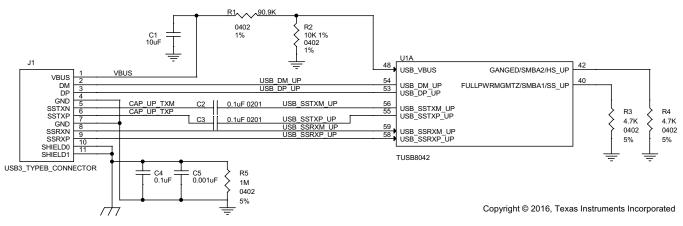
DESIGN PARAMETER	EXAMPLE VALUE					
VDD Supply	1.1 V					
VDD33 Supply	3.3 V					
Upstream Port USB Support (SS, HS, FS)	SS, HS, FS					
Downstream Port 1 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS					
Downstream Port 2 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS					
Downstream Port 3 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS					
Downstream Port 4 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS					
Number of Removable external exposed Downstream Ports	4					
Number of Non-Removable external exposed Downstream Ports	0					
Full Power Management of Downstream Ports	Yes. (FULLPWRMGMTZ = 0)					
Individual Control of Downstream Port Power Switch	Yes. (GANGED = 0)					
Power Switch Enable Polarity	Active High. (PWRCTL_POL = 1)					
Battery Charge Support for Downstream Port 1	Yes					
Battery Charge Support for Downstream Port 2	Yes					
Battery Charge Support for Downstream Port 3	Yes					
Battery Charge Support for Downstream Port 4	Yes					
I2C EEPROM Support	No					
24MHz Clock Source	Crystal					

Table 31. Design Parameters

9.2.1.2 Detailed Design Procedure

9.2.1.2.1 Upstream Port Implementation

The upstream of the TUSB8042 is connected to a USB3 Type B connector. This particular example has GANGED pin and FULLPWRMGMTZ pin pulled low which results in individual power support each downstream port. The VBUS signal from the USB3 Type B connector is feed through a voltage divider. The purpose of the voltage divider is to make sure the level meets USB_VBUS input requirements

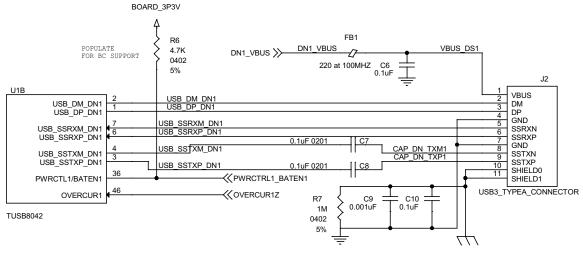






9.2.1.2.2 Downstream Port 1 Implementation

The downstream port 1 of the TUSB8042 is connected to a USB3 Type A connector. With BATEN1 pin pulled up, Battery Charge support is enabled for Port 1. If Battery Charge support is not needed, then pull-up resistor on BATEN1 should be uninstalled.

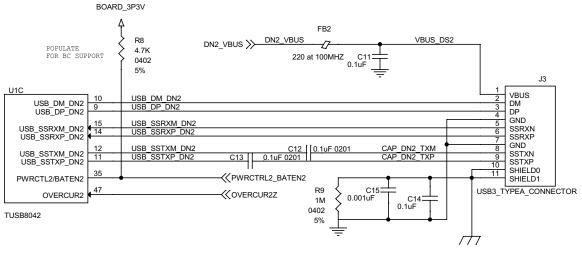


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9.2.1.2.3 Downstream Port 2 Implementation

The downstream port 2 of the TUSB8042 is connected to a USB3 Type A connector. With BATEN2 pin pulled up, Battery Charge support is enabled for Port 2. If Battery Charge support is not needed, then pull-up resistor on BATEN2 should be uninstalled. For ferrite bead used on the VBUS connection, a lower resistance is recommended due to noticeable IR drop during high current charging modes. The isolation between the Type-A connectors shield ground and signal ground pins is not required. Some applications may have better ESD/EMI performance when the grounds are shorted together.



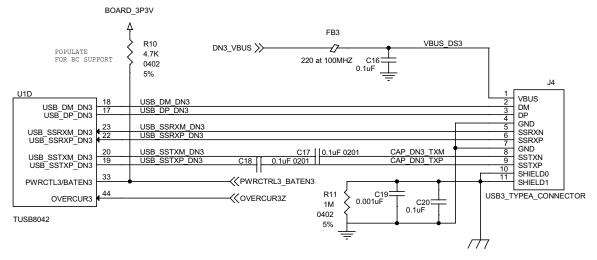
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Figure 30. Downstream Port 2 Implementation



9.2.1.2.4 Downstream Port 3 Implementation

The downstream port3 of the TUSB8042 is connected to a USB3 Type A connector. With BATEN3 pin pulled up, Battery Charge support is enabled for Port 3. If Battery Charge support is not needed, then pull-up resistor on BATEN3 should be uninstalled. For ferrite bead used on the VBUS connection, a lower resistance is recommended due to noticeable IR drop during high current charging modes. The isolation between the Type-A connectors shield ground and signal ground pins is not required. Some applications may have better ESD/EMI performance when the grounds are shorted together.

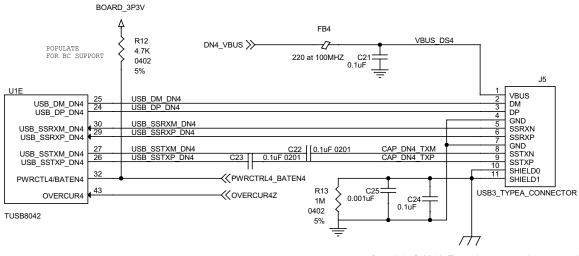


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Figure 31. Downstream Port 3 Implementation

9.2.1.2.5 Downstream Port 4 Implementation

The downstream port 4 of the TUSB8042 is connected to a USB3 Type A connector. With BATEN4 pin pulled up, Battery Charge support is enabled for Port 4. If Battery Charge support is not needed, then pull-up resistor on BATEN4 should be uninstalled. For ferrite bead used on the VBUS connection, a lower resistance is recommended due to noticeable IR drop during high current charging modes. The isolation between the Type-A connectors shield ground and signal ground pins is not required. Some applications may have better ESD/EMI performance when the grounds are shorted together.



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Figure 32. Downstream Port 4 Implementation



9.2.1.2.6 VBUS Power Switch Implementation

This particular example uses the Texas Instruments TPS2561 Dual Channel Precision Adjustable Current-Limited power switch. For details on this power switch or other power switches available from Texas Instruments, refer to the Texas Instruments website.

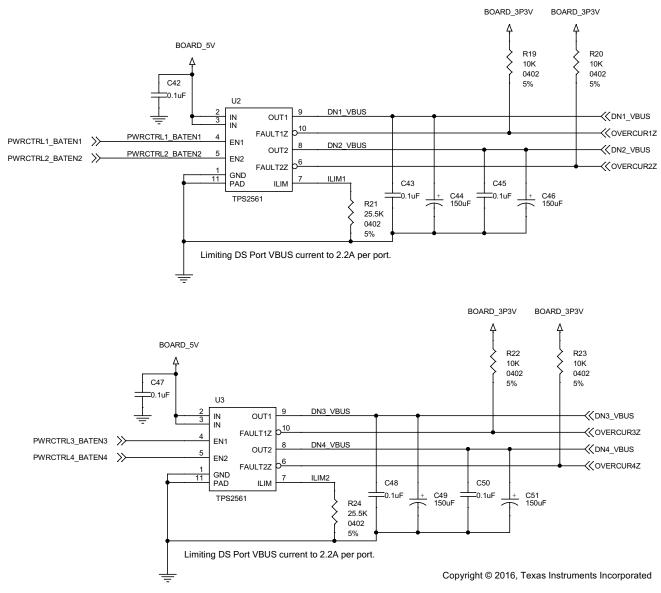


Figure 33. VBUS Power Switch Implementation

9.2.1.2.7 Clock, Reset, and Misc

The PWRCTL_POL is left unconnected which results in active high power enable (PWRCTL1, PWRCTL2, PWRCTL3, and PWRCTL4) for a USB VBUS power switch. SMBUSz pin is also left unconnected which will select I2C mode. Both PWRCTL_POL and SMBUSz pins have internal pull-ups. The 1 µF capacitor on the GRSTN pin can only be used if the VDD11 supply is stable before the VDD33 supply. The depending on the supply ramp of the two supplies the capacitor size may have to be adjusted.

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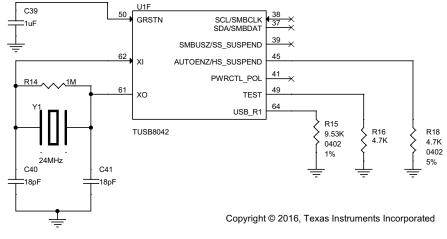


Figure 34. Clock, Reset, and Misc



9.2.1.2.8 TUSB8042 Power Implementation

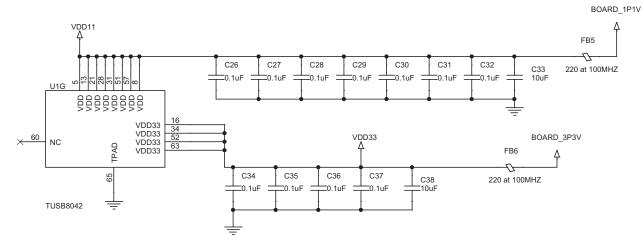
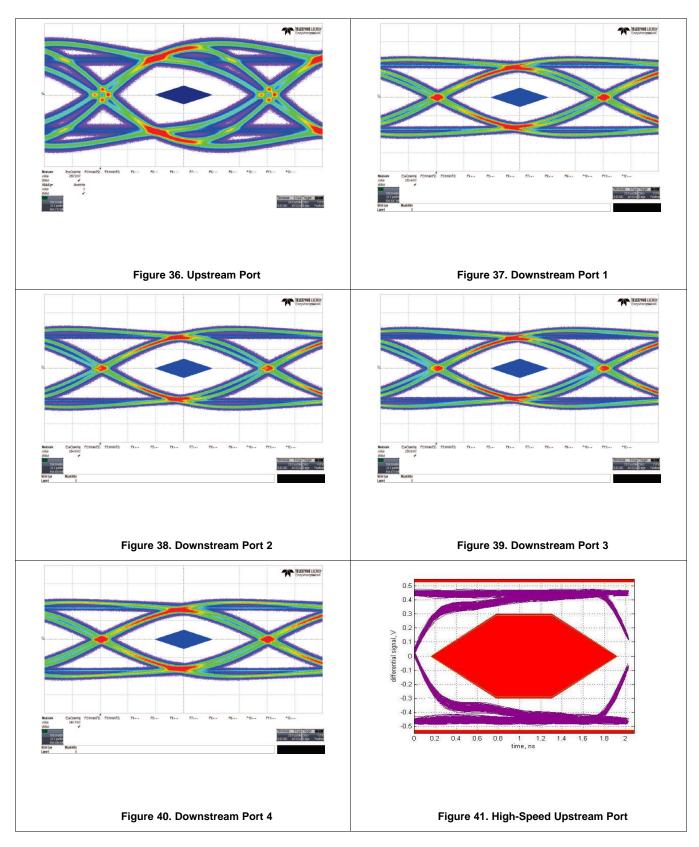


Figure 35. TUSB8042 Power Implementation

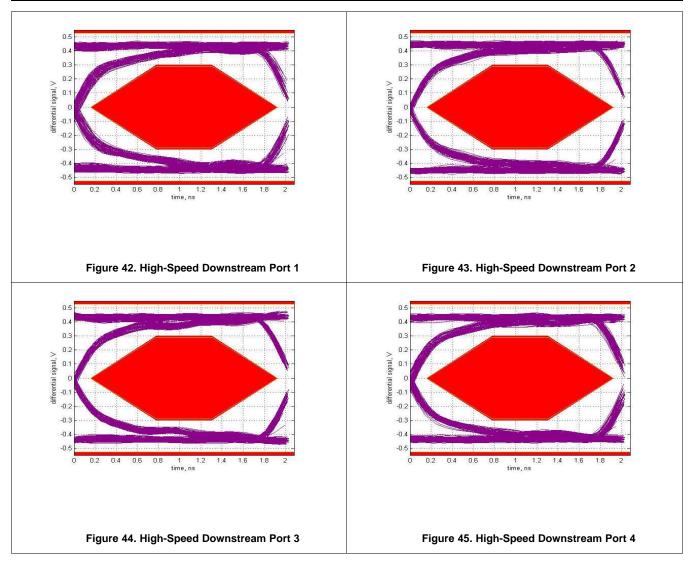
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9.2.1.3 Application Curves









10 Power Supply Recommendations

10.1 TUSB8042 Power Supply

 V_{DD} should be implemented as a single power plane, as should V_{DD33} .

- The V_{DD} pins of the TUSB8042 supply 1.1 V (nominal) power to the core of the TUSB8042. This power rail can be isolated from all other power rails by a ferrite bead to reduce noise.
- The DC resistance of the ferrite bead on the core power rail can affect the voltage provided to the device due to the high current draw on the power rail. The output of the core voltage regulator may need to be adjusted to account for this or a ferrite bead with low DC resistance (less than 0.05Ω) can be selected.
- The V_{DD33} pins of the TUSB8042 supply 3.3 V power rail to the I/O of the TUSB8042. This power rail can be isolated from all other power rails by a ferrite bead to reduce noise.
- All power rails require a 10 µF capacitor or 1 µF capacitors for stability and noise immunity. These bulk capacitors can be placed anywhere on the power rail. The smaller decoupling capacitors should be placed as close to the TUSB8042 power pins as possible with an optimal grouping of two of differing values per pin.

10.2 Downstream Port Power

- The downstream port power, VBUS, must be supplied by a source capable of supplying 5V and up to 900 mA
 per port. Downstream port power switches can be controlled by the TUSB8042 signals. It is also possible to
 leave the downstream port power always enabled.
- A large bulk low-ESR capacitor of 22 µF or larger is required on each downstream port's VBUS to limit in-rush current.
- The ferrite beads on the VBUS pins of the downstream USB port connections are recommended for both ESD and EMI reasons. A 0.1µF capacitor on the USB connector side of the ferrite provides a low impedance path to ground for fast rise time ESD current that might have coupled onto the VBUS trace from the cable.

10.3 Ground

It is recommended that only one board ground plane be used in the design. This provides the best image plane for signal traces running above the plane. The thermal pad of the TUSB8042 and any of the voltage regulators should be connected to this plane with vias. An earth or chassis ground is implemented only near the USB port connectors on a different plane for EMI and ESD purposes.



11 Layout

11.1 Layout Guidelines

11.1.1 Placement

- 1. 9.53K +/-1% resistor connected to pin USB_R1 should be placed as close as possible to the TUSB8042.
- 2. A 0.1 μ F should be placed as close as possible on each VDD and VDD33 power pin.
- 3. The 100 nF capacitors on the SSTXP and SSTXM nets should be placed close to the USB connector (Type A, Type B, and so forth).
- 4. The ESD and EMI protection devices (if used) should also be placed as close as possible to the USB connector.
- 5. If a crystal is used, it must be placed as close as possible to the TUSB8042 XI and XO pins.
- 6. Place voltage regulators as far away as possible from the TUSB8042, the crystal, and the differential pairs.
- 7. In general, the large bulk capacitors associated with each power rail should be placed as close as possible to the voltage regulators.

11.1.2 Package Specific

- 1. The TUSB8042 package has a 0.5-mm pin pitch.
- 2. The TUSB8042 package has a 6.0-mm x 6.0-mm thermal pad. This thermal pad must be connected to ground through a system of vias.
- 3. All vias under device, except for those connected to thermal pad, should be solder masked to avoid any potential issues with thermal pad layouts.

11.1.3 Differential Pairs

This section describes the layout recommendations for all the TUSB8042 differential pairs: USB_DP_XX, USB_DM_XX, USB_SSTXP_XX, USB_SSTXM_XX, USB_SSRXP_XX, and USB_SSRXM_XX.

- 1. Must be designed with a differential impedance of 90 Ω ±10%.
- 2. In order to minimize cross talk, it is recommended to keep high speed signals away from each other. Each pair should be separated by at least 5 times the signal trace width. Separating with ground as depicted in the layout example will also help minimize cross talk.
- 3. Route all differential pairs on the same layer adjacent to a solid ground plane.
- 4. Do not route differential pairs over any plane split.
- 5. Adding test points will cause impedance discontinuity and will therefore negative impact signal performance. If test points are used, they should be placed in series and symmetrically. They must not be placed in a manner that causes stub on the differential pair.
- 6. Avoid 90 degree turns in trace. The use of bends in differential traces should be kept to a minimum. When bends are used, the number of left and right bends should be as equal as possible and the angle of the bend should be ≥ 135 degrees. This will minimize any length mismatch causes by the bends and therefore minimize the impact bends have on EMI.
- 7. Minimize the trace lengths of the differential pair traces. The maximum recommended trace length for SS differential pair signals and USB 2.0 differential pair signals is eight inches. Longer trace lengths require very careful routing to assure proper signal integrity.
- 8. Match the etch lengths of the differential pair traces (i.e. DP and DM or SSRXP and SSRXM or SSTXP and SSTXM). There should be less than 5 mils difference between a SS differential pair signal and its complement. The USB 2.0 differential pairs should not exceed 50 mils relative trace length difference.
- 9. The etch lengths of the differential pair groups do not need to match (i.e. the length of the SSRX pair to that of the SSTX pair), but all trace lengths should be minimized.
- 10. Minimize the use of vias in the differential pair paths as much as possible. If this is not practical, make sure that the same via type and placement are used for both signals in a pair. Any vias used should be placed as close as possible to the TUSB8042 device.
- 11. To ease routing, the polarity of the SS differential pairs can be swapped. This means that SSTXP can be routed to SSTXM or SSRXM can be routed to SSRXP.



Layout Guidelines (continued)

- 12. To ease routing of the USB2 DP and DM pair, the polarity of these pins can be swapped. If this is done, the appropriate Px_usb2pol register, where x = 0, 1, 2, 3, or 4, must be set.
- 13. Do not place power fuses across the differential pair traces.

11.2 Layout Examples

11.2.1 Upstream Port

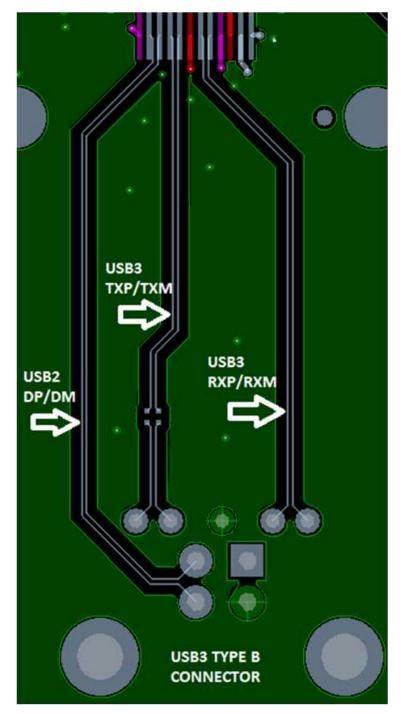


Figure 46. Example Routing of Upstream Port



Layout Examples (continued)

11.2.2 Downstream Port

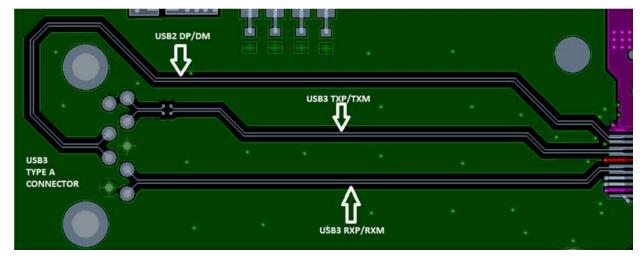


Figure 47. Example Routing of Downstream Port

The remaining three downstream ports routing can be similar to the example provided.

12 Device and Documentation Support

12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E[™] Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.3 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

12.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

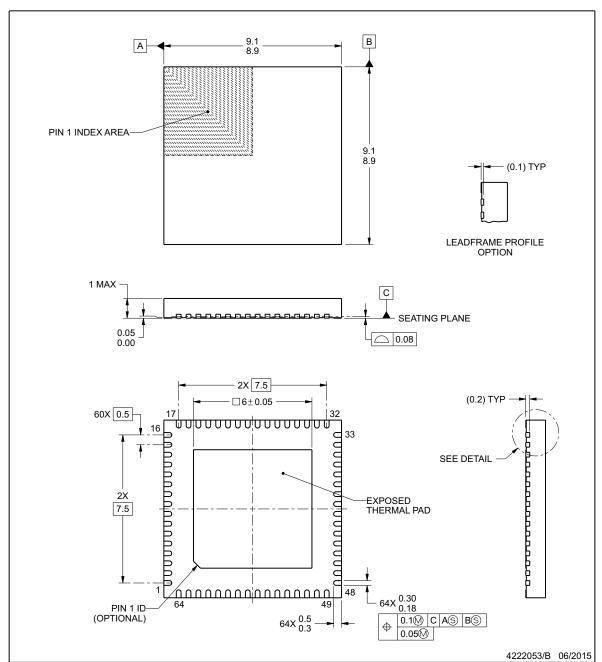
13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.

3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAS

NSTRUMENTS

RGC0064G



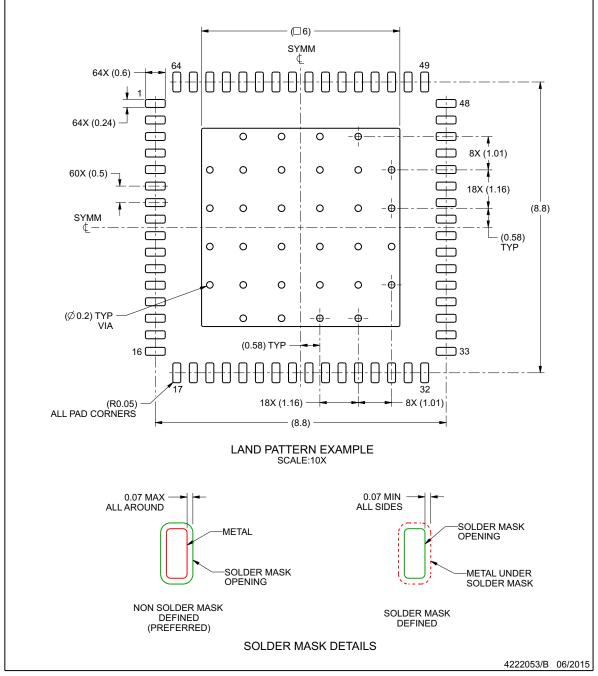


EXAMPLE BOARD LAYOUT

RGC0064G

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

 This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

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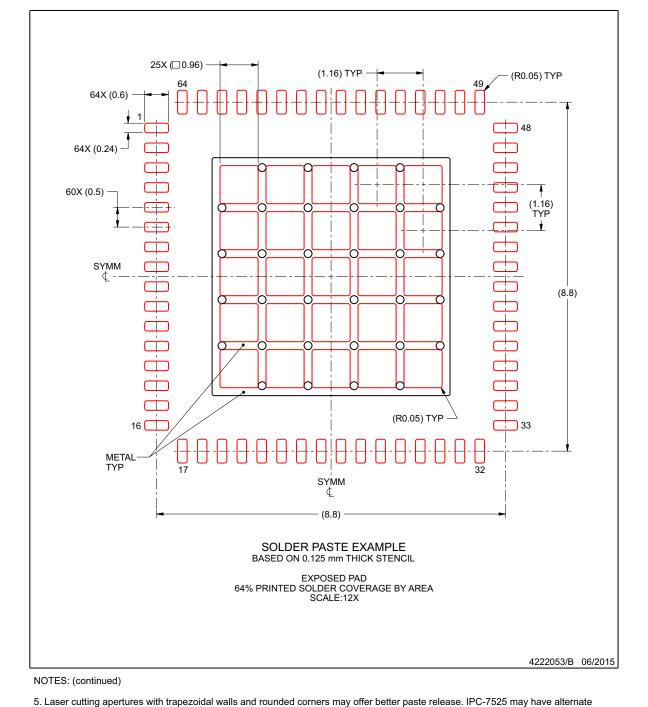
Product Folder Links: TUSB8042

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EXAMPLE STENCIL DESIGN

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



design recommendations.

RGC0064G



15-Aug-2017

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
TUSB8042RGCR	PREVIEW	VQFN	RGC	64	2000	TBD	Call TI	Call TI	0 to 70		
TUSB8042RGCT	PREVIEW	VQFN	RGC	64	250	TBD	Call TI	Call TI	0 to 70		

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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